



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary (Typ. @ VGS = 3.3V, TA = +25°C)

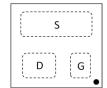
V _{DSS}	R _{DS(ON)}	Qg	Q_{gd}	ΙD
12V	14.1mΩ	10.5nC	4.1nC	7.5A

Description

This new generation MOSFET is engineered to minimize on-state losses and switch ultra-fast, making it ideal for high efficiency power transfer. Using Chip-Scale Package (CSP) to increase power density by combining low thermal impedance with minimal RDS(ON) per footprint area.

Applications

- DC-DC Converters
- Battery Management
- Load Switch



Top-View Pin Configuration

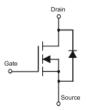
Features

- TR-MOS Technology with the Lowest R_{DS(ON)}:
 R_{DS(ON)} = 14.1mΩ to Minimize On-State Losses
- CSP with Footprint 1.0mm × 1.0mm
- Height = 0.29mm for Low Profile
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: X3-DSN1010-3
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminal Finish: Matte Tin Annealed Over Copper Pillar (3)
- Solder Cap Material: SnAg (Ag: 2.0+/-0.5%)
- Weight: 0.00062 grams (Approximate)



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN1017UCP3-7	X3-DSN1010-3	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/



Marking Information (Note 5)

Marking 1

4B YM 4B = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: I = 2021) M or \overline{M} = Month (ex: 9 = September)

Date Code Key

Year	2017		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	Е			J	K	L	М	Ν	0	Р	R	S
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Marking 2



4B = Product Type Marking Code YW = Date Code Marking Y or \overline{Y} = Year (ex: 1 = 2021) W or \overline{W} = Week (ex: a = Week 27; z Represents Week 52 and 53)

Date Code Key

Ī	Year	2017	 2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Ī	Code	7	 1	2	3	4	5	6	7	8	9	0

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Note:

5. The marking code changed to Marking 2 from week 6, 2021.



Maximum Ratings

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	12	V	
Gate-Source Voltage	V_{GSS}	±8	V	
Continuous Drain Current @ VGS = 3.3V (Note 6)	$T_A = +25$ °C $T_A = +70$ °C	l _D	5.4 4.3	Α
Continuous Drain Current @ VGS = 3.3V (Note 7)	l _D	7.5 6.1	А	
Pulsed Drain Current (Pulse Duration 10µs, Duty Cycle ≤	I _{DM}	15	Α	
Continuous Source-Drain Diode Current (Note 7)	ls	1.47	Α	
Pulse Diode Forward Current (Note 7)		I _{SM}	15	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 6)	P _D	0.74	W
Thermal Resistance, Junction to Ambient (Note 6)	R _θ JA	167	°C/W
Total Power Dissipation (Note 7)	PD	1.47	W
Thermal Resistance, Junction to Ambient (Note 7)	R _θ JA	85	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

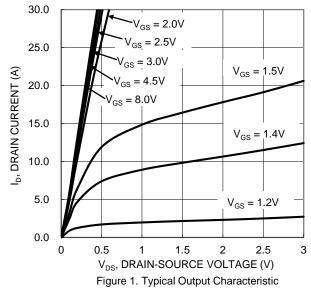
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

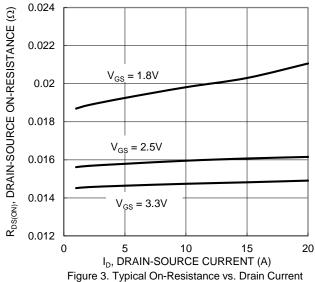
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)				•		
Drain-Source Breakdown Voltage	BV _{DSS}	12	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	1.0	μΑ	$V_{DS} = 9.6V, V_{GS} = 0V$
Gate-Body Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	VGS(TH)	0.4	0.7	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
		-	14.1	17.0		$V_{GS} = 3.3V, I_{D} = 5.0A$
		_	14.4	19.0		$V_{GS} = 3.0V, I_{D} = 5.0A$
			15.5	21.0		$V_{GS} = 2.5V, I_D = 5.0A$
Static Drain-Source On-Resistance	R _{DS(ON)}		16.0	23.0	mΩ	$V_{GS} = 2.3V, I_D = 5.0A$
			16.8	24.0		VGS = 2.1V, ID = 5.0A
		_	21.3	34.0		V _{GS} = 2.1V, I _D = 5.0A, +125°C (Note 9)
		_	20.0	30.0		$V_{GS} = 1.8V, I_{D} = 3.0A$
Forward Transfer Admittance	Y _{fs}	_	6.6	_	S	V _{DS} = 6V, I _S = 1.0A
Body Diode Forward Voltage	VsD	_	0.7	1	V	VGS = 0V, IS = 1.0A
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	_	1002	1503	pF	-\/
Output Capacitance	Coss	_	312	468	pF	V _{DS} = 6V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	-	259	389	pF	1 = 1.0WH2
Gate Resistance	Rg	1	2.2	4.4	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge	Qg		10.5	16	nC	\\ 2 2\\ \\ 6\\
Gate-Source Charge	Qgs		1.0	1.5	nC	$V_{GS} = 3.3V, V_{DS} = 6V,$ $I_{D} = 5.0A$
Gate-Drain Charge	Q_{gd}		4.1	6.2	nC	1D = 5.0A
Turn-On Delay Time	td(ON)		3.7	10	ns	
Turn-On Rise Time	t _R	_	6.3	15	ns	$V_{DD} = 6V, I_D = 5.0A$
Turn-Off Delay Time	tD(OFF)	_	17.9	35	ns	$V_{GEN} = 4.5V$, $R_G = 1\Omega$, $R_L = 1.2\Omega$
Turn-Off Fall Time	t _F	_	7.5	15	ns	
Reverse Recovery Charge	Q _{RR}		2.7	5	nC	I_
Body Diode Reverse Recovery Time	trr	_	14.2	28	ns	I _F = 5A, di/dt = 100A/μs

Notes:

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.







and Gate Voltage

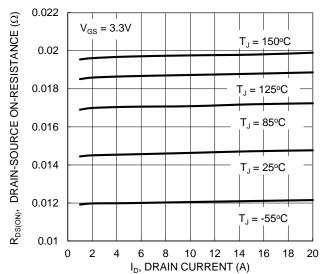
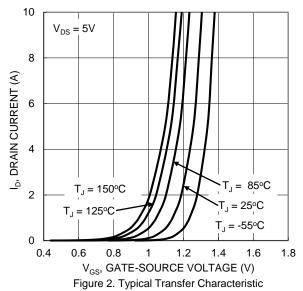
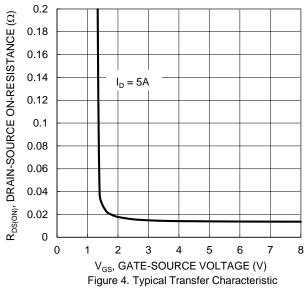


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





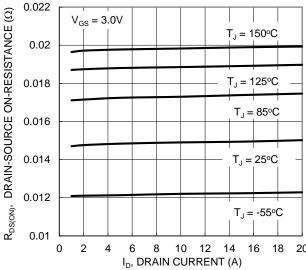


Figure 6. Typical On-Resistance vs. Drain Current and Junction Temperature



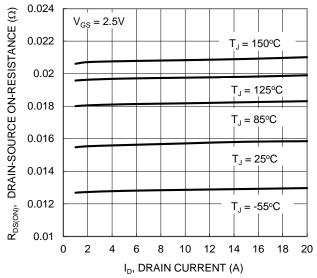


Figure 7. Typical On-Resistance vs. Drain Current and Junction Temperature

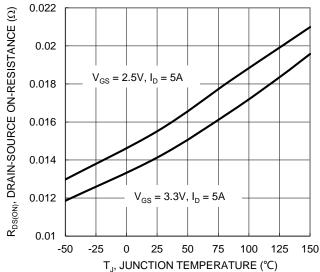


Figure 9. On-Resistance Variation with Junction
Temperature

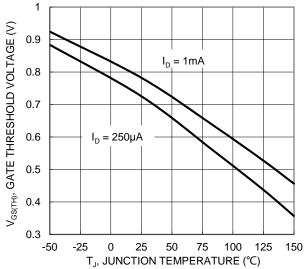
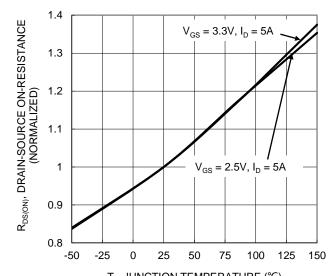


Figure 11. Gate Threshold Variation vs. Junction Temperature



 T_J , JUNCTION TEMPERATURE (°C) Figure 8. On-Resistance Variation with Junction Temperature

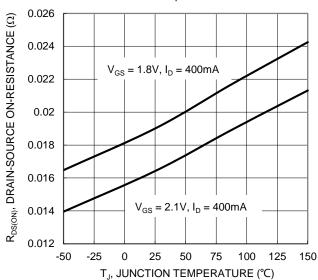


Figure 10. On-Resistance Variation with Junction Temperature

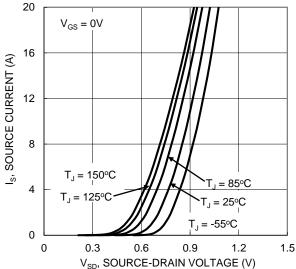
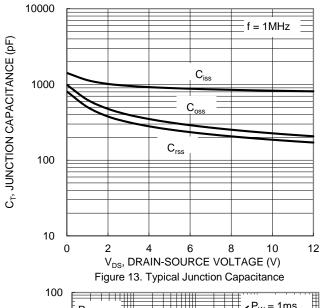
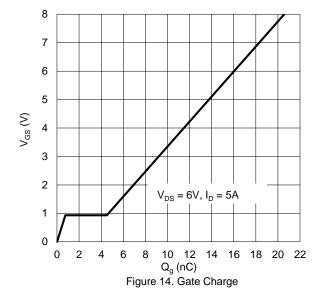


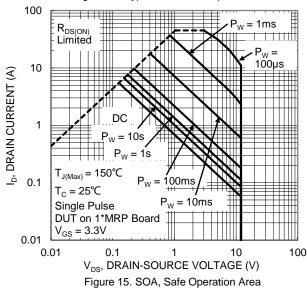
Figure 12. Diode Forward Voltage vs. Current











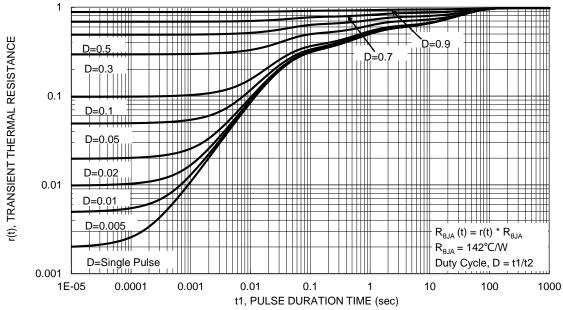


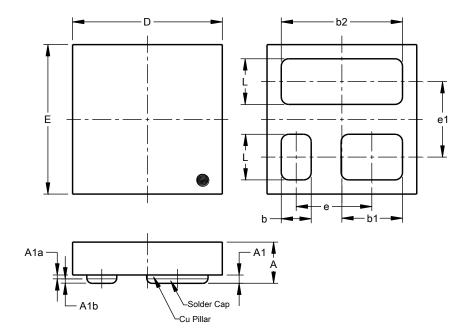
Figure 16. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X3-DSN1010-3

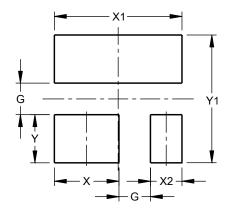


X3-DSN1010-3						
Dim	Min	Max	Тур			
Α	-	0.29	0.27			
A1	0.034	0.046	0.04			
A1a	0.015	0.025	0.02			
A1b	0.017	0.023	0.02			
b	0.18	0.22	0.20			
b1	0.39	0.43	0.41			
b2	0.79	0.83	0.81			
D	0.92	1.00	0.96			
Е	0.92	1.00	0.96			
е	-	-	0.505			
e1	-	-	0.505			
L	0.285	0.325	0.305			
All	Dimens	ions in	mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X3-DSN1010-3



Dimensions	(in mm)
G	0.200
X	0.410
X1	0.810
X2	0.200
Y	0.305
Y1	0.810



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